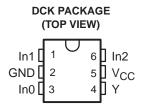
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- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree<sup>†</sup>
- Supports 5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 6.3 ns at 3.3 V
- Low Power Consumption, 10-μA Max I<sub>CC</sub>

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- ±24-mA Output Drive at 3.3 V
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- Choose From Nine Specific Logic Functions



### description/ordering information

This configurable multiple-function gate is designed for 1.65-V to 5.5-V V<sub>CC</sub> operation.

The SN74LVC1G97 features configurable multiple functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter, and noninverter. All inputs can be connected to  $V_{CC}$  or GND.

This device functions as an independent gate, but because of Schmitt action, it may have different input threshold levels for positive-going ( $V_{T+}$ ) and negative-going ( $V_{T-}$ ) signals.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

### **ORDERING INFORMATION**

TA	PACKAGE <sup>‡</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	SOT (SC-70) - DCK	Tape and reel	SN74LVC1G97IDCKREP	CSR

<sup>‡</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



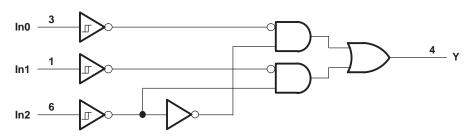
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



### **FUNCTION TABLE**

	INPUTS	OUTPUT	
ln2	ln1	In0	Υ
L	L	L	L
L	L	Н	L
L	Н	L	Н
L	Н	Н	Н
Н	L	L	L
Н	L	Н	Н
Н	Н	L	L
Н	Н	Н	Н

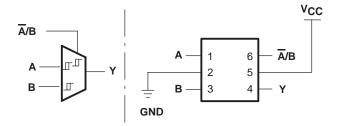
### logic diagram (positive logic)



### **FUNCTION SELECTION TABLE**

LOGIC FUNCTION	FIGURE NO.
2-to-1 data selector	1
2-input AND gate	2
2-input OR gate with one inverted input	3
2-input NAND gate with one inverted input	3
2-input AND gate with one inverted input	4
2-input NOR gate with one inverted input	4
2-input OR gate	5
Inverter	6
Noninverted buffer	7

### logic configurations



**VCC** 5 亍 2 3 4 **GND** 

Figure 1. 2-to-1 Data Selector

VCC 6 2 5 3 4 **GND** 

Figure 2. 2-Input AND Gate

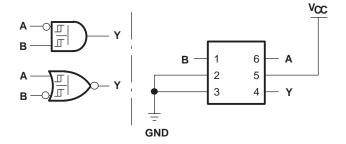
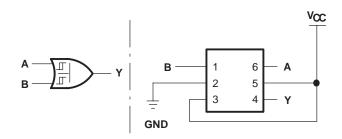


Figure 3. 2-Input OR Gate With One Inverted Input
2-Input NAND Gate With One Inverted Input

Figure 4. 2-Input AND Gate With One **Inverted Input** 2-Input NOR Gate With One Inverted Input



**VCC** 6 Α 2 5 3 **GND** 

Figure 5. 2-Input OR Gate

Figure 6. Inverter

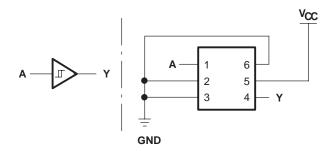


Figure 7. Noninverted Buffer



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, VO	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, IO	±50 mA
Continuous current through V <sub>CC</sub> or GND	±100 mA
Package thermal impedance, θ <sub>.IA</sub> (see Note 3)	259°C/W
Storage temperature range, T <sub>stg</sub>	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The value of  $V_{\hbox{\scriptsize CC}}$  is provided in the recommended operating conditions table.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 4)

		<u>.</u>	MIN	MAX	UNIT	
	Own throughtons	Operating	1.65	5.5	.,	
VCC	Supply voltage	Data retention only	1.5		V	
VI	Input voltage		0	5.5	V	
VO	Output voltage		0	VCC	V	
		V <sub>CC</sub> = 1.65 V		-4		
	IOH High-level output current	V <sub>CC</sub> = 2.3 V		-8		
lOH				-16	mA	
		VCC = 3 V		-24		
		V <sub>CC</sub> = 4.5 V		-32		
		V <sub>CC</sub> = 1.65 V		4		
		V <sub>CC</sub> = 2.3 V		8		
lOL	I <sub>OL</sub> Low-level output current	V 0V		16	mA	
		VCC = 3 V		24		
		V <sub>CC</sub> = 4.5 V		32		
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST COM	NDITIONS	VCC	MIN	TYPT M	ΑX	UNIT
			1.65 V	0.79	1.	16	
V <sub>T+</sub>			2.3 V	1.11	1.	56	
Positive-going input threshold			3 V	1.5	1.	87	V
voltage			4.5 V	2.16	2.	74	
			5.5 V	2.61	3.	33	
			1.65 V	0.39	0.	62	
V <sub>T</sub> _			2.3 V	0.58	0.	87	
Negative-going input threshold			3 V	0.84	1.	14	V
voltage			4.5 V	1.41	1.	79	
			5.5 V	1.87	2.	29	
			1.65 V	0.37	0.	62	
ΔVT			2.3 V	0.48	0.	77	
Hysteresis			3 V	0.56	0.	87	V
$(V_{T+} - V_{T-})$			4.5 V	0.71	1.	04	
			5.5 V	0.71	1	11	
	I <sub>OH</sub> = -100 μA		1.65 V to 5.5 V	V <sub>CC</sub> -0.1			
	$I_{OH} = -4 \text{ mA}$		1.65 V	1.2			
	IOH = -8  mA		2.3 V	1.9			.,
	I <sub>OH</sub> = -16 mA		3 V	2.4			V
	I <sub>OH</sub> = -24 mA		3 V	2.3			
	$I_{OH} = -32 \text{ mA}$		4.5 V	3.8			
	I <sub>OL</sub> = 100 μA		1.65 V to 5.5 V		(	).1	
	$I_{OL} = 4 \text{ mA}$		1.65 V		0.	45	
.,	$I_{OL} = 8 \text{ mA}$		2.3 V		(	0.3	
VOL	I <sub>OL</sub> = 16 mA		2.1/		(	).4	V
	I <sub>OL</sub> = 24 mA		3 V		0.	55	
	I <sub>OL</sub> = 32 mA		4.5 V		0.	55	
Ц	V <sub>I</sub> = 5.5 V or GND		0 to 5.5 V			±5	μΑ
l <sub>off</sub>	V <sub>I</sub> or V <sub>O</sub> = 5.5 V		0		<u>+</u>	10	μΑ
ICC	$V_I = 5.5 \text{ V or GND},$	IO = 0	1.65 V to 5.5 V			10	μΑ
ΔlCC	One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 5.5 V		5	00	μΑ
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND		3.3 V	_	3.5		pF

 $<sup>\</sup>dagger$  All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

# SN74LVC1G97-EP CONFIGURABLE MULTIPLE-FUNCTION GATE

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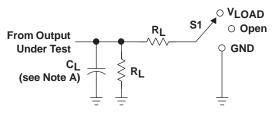
# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 8)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 5 V ± 0.5 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	,
t <sub>pd</sub>	Any In	Υ	3.2	14.4	2	8.3	1.5	6.3	1.1	5.1	ns

### operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST	V <sub>CC</sub> = 1.8 V	$V_{CC} = 2.5 V$	$V_{CC} = 3.3 \text{ V}$	$V_{CC} = 5 V$	LINUT
	FARAMETER	CONDITIONS	TYP	TYP	TYP	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	f = 10 MHz	22	23	23	26	pF

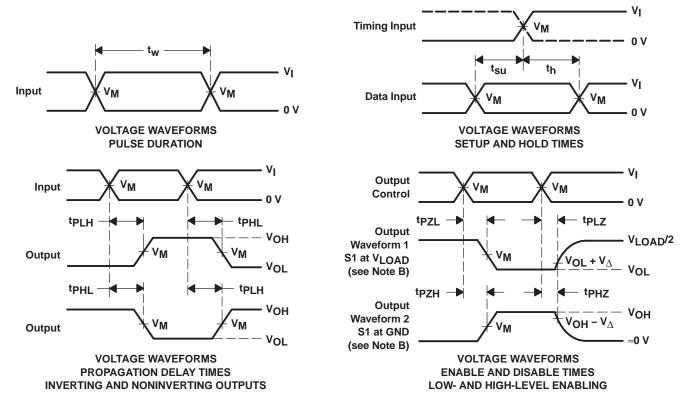
### PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

**LOAD CIRCUIT** 

.,	INF	INPUTS V <sub>M</sub>				_	.,
VCC	VI	t <sub>r</sub> /t <sub>f</sub>	νM	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V $\pm$ 0.15 V	VCC	≤2 ns	V <sub>CC</sub> /2	2×VCC	30 pF	<b>1 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	VCC	≤2 ns	V <sub>CC</sub> /2	2×VCC	30 pF	500 Ω	0.15 V
3.3 V $\pm$ 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
5 V $\pm$ 0.5 V	VCC	≤2.5 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	50 pF	500 Ω	0.3 V



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

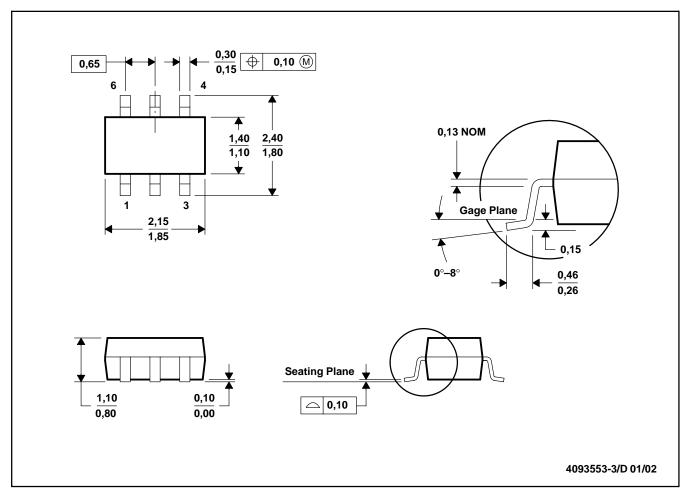
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>Q</sub> = 50 Ω.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 8. Load Circuit and Voltage Waveforms



### DCK (R-PDSO-G6)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-203

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